

General Notification

202502001G: Freescale Logo to NXP Logo Product Marking Conversion for All Remaining Former Freescale Products

Note: This notice is NXP Company Proprietary.

Issue Date: Feb 16, 2025

Management summary

NXP Semiconductors announces the Freescale logo to NXP logo product marking conversion for all former Freescale products not previously converted. This NXP marking initiative achieves unified NXP branding for the entire portfolio.

GN Overview

General Information

NXP Semiconductors announces the Freescale logo to NXP logo product marking conversion for all former Freescale products not previously converted. This NXP marking initiative achieves unified NXP branding for the entire portfolio.

The anticipated timeline for this Freescale logo to NXP logo product marking conversion aligns with product date code / trace code beginning work week (ww) 22 2025 (last week May 2025), with a ramped implementation over subsequent weeks until all product marking conversion is completed, anticipated ww27 2025, with minimal exceptions. With the standard NXP lot combination practices, which seek to avoid excessive product scrappage, customers may indeed receive product with mixed Freescale and NXP logo markings within shipment trays, tubes, or reels.

This General Notification 202502001G is issued well in advance of the NXP logo conversion implementation date to ensure no customer manufacturing disruptions occur with potential Automated Optical Inspections (AOI), etc. Except for visible Freescale logo to NXP logo change, absolutely no other changes; no change to orderable part numbers, no impact on product form, fit, function, quality, or reliability compared to the product currently received by customers.

Please see the attachment for change details, including representative before and after product logo photos. Note, these are simply representative package types / photos and not intended to capture all package / part instances.

NXP strongly advises that this General Notification and its associated example logo photos be relayed to your site's AOI owners / experts to review your systems and take precautions to avoid manufacturing line disruptions. Although from NXP side we expect the logo to not be part of any potential customer AOI inspection area, only your experts will be able to judge any potential impact. NXP greatly appreciates your cooperation to review and complete this important action item at your earliest opportunity.

If you have any questions, please send email to: Karina Juhasz / Quality Engineer / @karina.juhasz@nxp.com

Reason

Freescale logo to NXP logo product marking conversion for all former Freescale products not previously converted to achieve unified NXP branding for the entire NXP portfolio

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards. Customer Focus, Passion to Win.

NXP Quality Management Team.

About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

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High Tech Campus, 5656 AG Eindhoven, The Netherlands

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NXP Semiconductors High Tech Campus, 5656 AG Eindhoven, The Netherlands

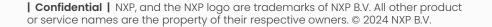
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Package	Current Freescale Logo Marking	New NXP Logo Marking
PQFN	MC144T IN71K ALYWZ	MC144T IN71K ALYWZ
BGA/LGA/FCCSP	MCIMX233DJM4C A5 M88S CTDQ1846G CHINA	MCIMX233DJM4C A5 M88S CTDQ1846G CHINA
L/QFP 10x10	MC9508AW60 CFGE 5M75B	MC9SOBAW60 CFGE 5M75B
QFN 5x5	13202 4UCCX	N#P 1.3 13202 4UCCX



Package	Current Freescale Logo Marking	New NXP Logo Marking
SOIC16	MC9080Y4AC DHE 0M82Z	HC9880Y4AC DHE 8M82Z NAPCTHG2343D
QFN 7x7	MK 10DN31VF MMMMM AWLYWZ	NAPMK 10DN31VF MMMMM AWLYWZ
LGA 9x9	* 1.1 MC13213 P3545.00 CTND1933G CHINA	* NMP 1.1 MC13213 P3545.00 CTND1933G CHINA
TSSOP	MGG4 CDTE BM85M ALYWZ	D MQG4 2 CDTE 8M85M ALYWZ



Package	Current Freescale Logo Marking	New NXP Logo Marking
LQFP/QFP/PLCC	F932K146UAVLL ON73V QAN2443N	FS32K146UAVLL ON73V QAN2443N
PBGA 27x27	MPC8313EVRAFFC 333/333 MHZ 0762437 MALAYSIA 2M03R XIFZQAL	MPC8313EVRAFFC 333/333 MHZ 0262437 MALAYSIA
PLD	N 0 Q LP2234A	NOPAFS12 NOQ LP2234A
TO Standard	AZIZZSZBC QWL GAST	INPARTIZES OF THE PROPERTY OF



Package	Current Freescale Logo Marking	New NXP Logo Marking
P. Sensor Mpak	MPXM2202AS KFE435A	MPXM2202AS NOP KFE435A
P. Sensor SOP	MP3V5004DP RKU431A	MPXV50046 KRY443A
PBGA	MCIMXS36AVP8C an78C SBBG2448A KOREA	MCIMX534AVP8C MANAMA SEWLYTWWZ KOREA
WLCSP	MO2T5C ON33H UYAYSA	MO275C ON33H UYAYSA





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